

# MC10162

## Binary to 1-8 Decoder (High)

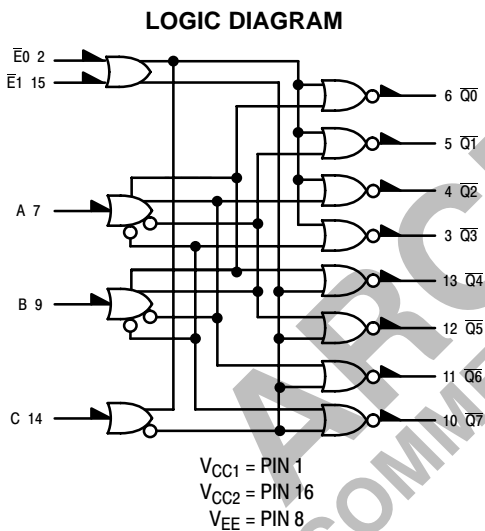
The MC10162 is designed to convert three lines of input data to a one-of-eight output. The selected output will be high while all other outputs are low. The enable inputs, when either or both are high, force all outputs low.

The MC10162 is a true parallel decoder. No series gating is used internally, eliminating unequal delay times found in other decoders.

This device is ideally suited for demultiplexer applications. One of the two enable inputs is used as the data input, while the other is used as a data enable input.

A complete mux/demux operation on 16 bits for data distribution is illustrated in Figure 1 of the MC10161 data sheet.

- $P_D = 315$  ns typ/pkg (No Load)
- $t_{pd} = 4.0$  ns typ
- $t_r, t_f = 2.0$  ns typ (20%–80%)



TRUTH TABLE

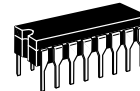
INPUTS					OUTPUTS							
E0	E1	C	B	A	Q0	Q1	Q2	Q3	Q4	Q5	Q6	Q7
L	L	L	L	L	H	L	L	L	L	L	L	L
L	L	L	L	H	L	H	L	L	L	L	L	L
L	L	L	H	L	L	L	H	L	L	L	L	L
L	L	L	H	H	L	L	L	H	L	L	L	L
L	L	H	L	L	L	L	L	L	H	L	L	L
L	L	H	L	H	L	L	L	L	L	H	L	L
L	L	H	H	L	L	L	L	L	L	L	H	L
L	L	H	H	H	L	L	L	L	L	L	L	H
H	X	X	X	X	L	L	L	L	L	L	L	L
X	H	X	X	X	L	L	L	L	L	L	L	L



ON Semiconductor

<http://onsemi.com>

### MARKING DIAGRAMS



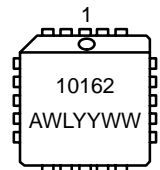
CDIP-16  
L SUFFIX  
CASE 620



PDIP-16  
P SUFFIX  
CASE 648

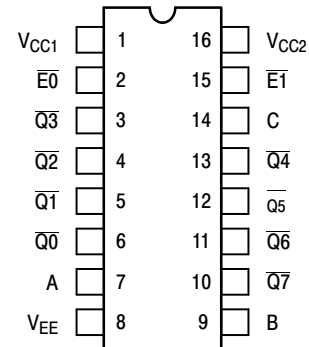


PLCC-20  
FN SUFFIX  
CASE 775



A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week

### DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

### ORDERING INFORMATION

Device	Package	Shipping
MC10162L	CDIP-16	25 Units / Rail
MC10162P	PDIP-16	25 Units / Rail
MC10162FN	PLCC-20	46 Units / Rail

# MC10162

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	$I_E$	8		84		61	76		84	mAdc
Input Current	$I_{inH}$	14		350			220		220	$\mu$ Adc
	$I_{inL}$	14	0.5		0.5			0.3		$\mu$ Adc
Output Voltage Logic 1	$V_{OH}$	13	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	$V_{OL}$	13	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		13	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	$V_{OHA}$	13	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	$V_{OLA}$	13		-1.655			-1.630		-1.595	Vdc
		13		-1.655			-1.630		-1.595	Vdc
Switching Times (50 $\Omega$ Load)										ns
Propagation Delay	$t_{14+13-}$ $t_{14-13+}$	13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	ns
		13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
Rise Time (20 to 80%)	$t_{13+}$	13	1.0	3.3	1.1	2.0	3.3	1.1	3.5	ns
Fall Time (20 to 80%)	$t_{13-}$	13	1.0	3.3	1.1	2.0	3.3	1.1	3.5	

## ELECTRICAL CHARACTERISTICS (continued)

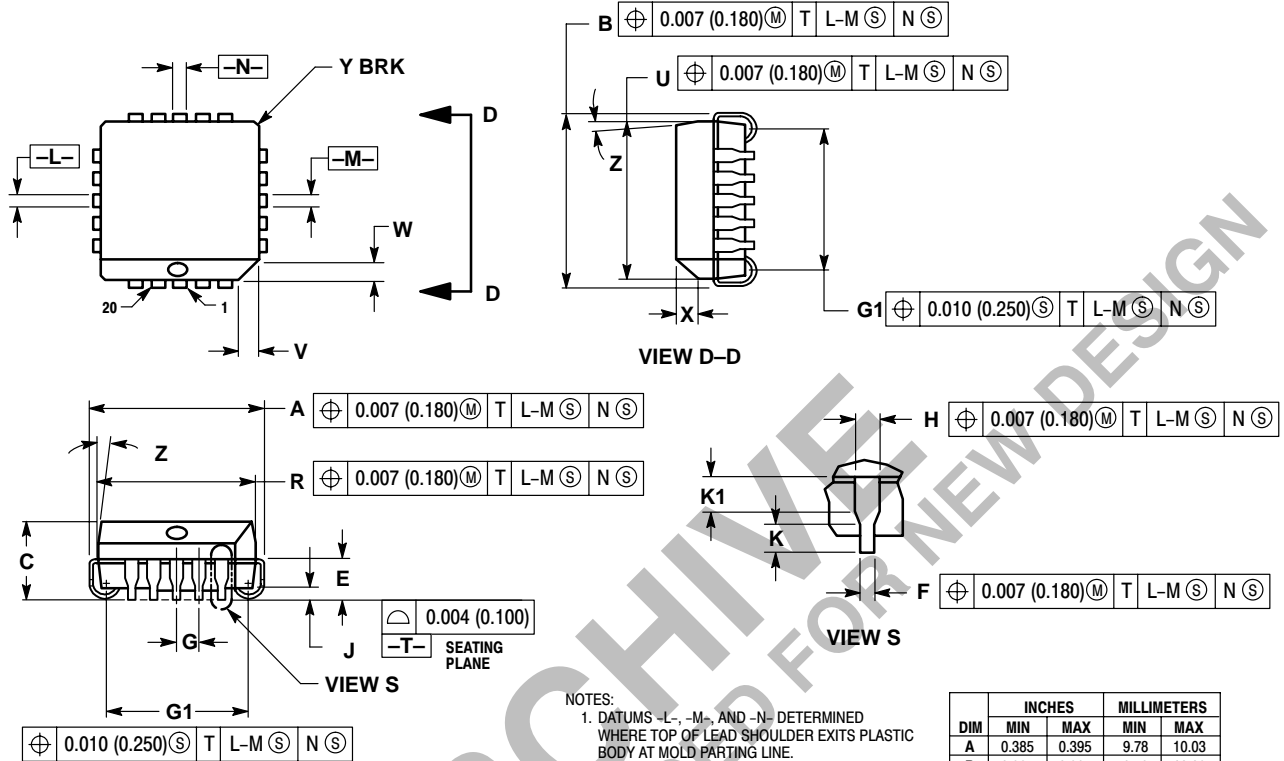
			TEST VOLTAGE VALUES (Volts)						
			$V_{IHmax}$	$V_{ILmin}$	$V_{IHmin}$	$V_{ILmax}$	$V_{EE}$		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					$(V_{CC})$ Gnd	
			$V_{IHmax}$	$V_{ILmin}$	$V_{IHmin}$	$V_{ILmax}$	$V_{EE}$		
Power Supply Drain Current	$I_E$	8					8	1,16	
Input Current	$I_{inH}$	14	14				8	1,16	
	$I_{inL}$	14		14			8	1,16	
Output Voltage Logic 1	$V_{OH}$	13	14				8	1,16	
Output Voltage Logic 0	$V_{OL}$	13	2				8	1,16	
		13	15				8	1,16	
Threshold Voltage Logic 1	$V_{OHA}$	13			14		8	1,16	
Threshold Voltage Logic 0	$V_{OLA}$	13			2		8	1,16	
		13			15		8	1,16	
Switching Times (50 $\Omega$ Load)						<b>Pulse In</b>	<b>Pulse Out</b>	<b>-3.2 V</b>	<b>+2.0 V</b>
Propagation Delay	$t_{14+13+}$ $t_{14-13-}$	13				14	13	8	1,16
		13				14	13	8	1,16
Rise Time (20 to 80%)	$t_+$	13				14	13	8	1,16
Fall Time (20 to 80%)	$t_-$	13				14	13	8	1,16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

# MC10162

## PACKAGE DIMENSIONS

PLCC-20  
FN SUFFIX  
PLASTIC PLCC PACKAGE  
CASE 775-02  
ISSUE C



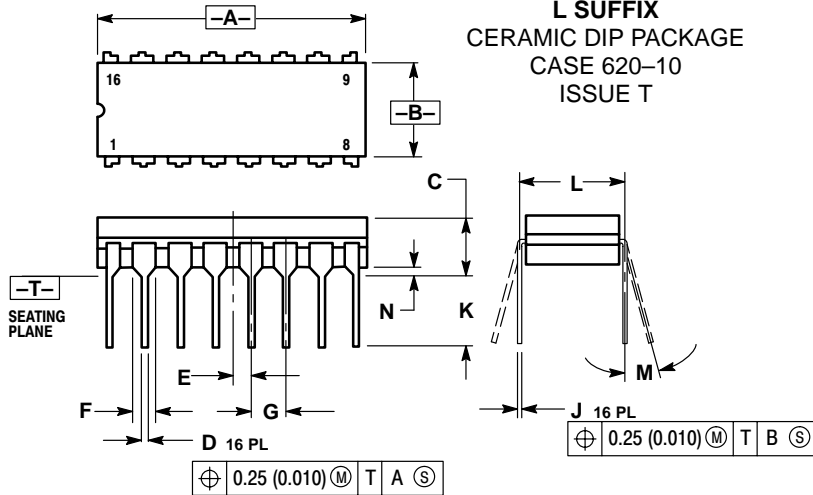
**NOTES:**

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

# MC10162

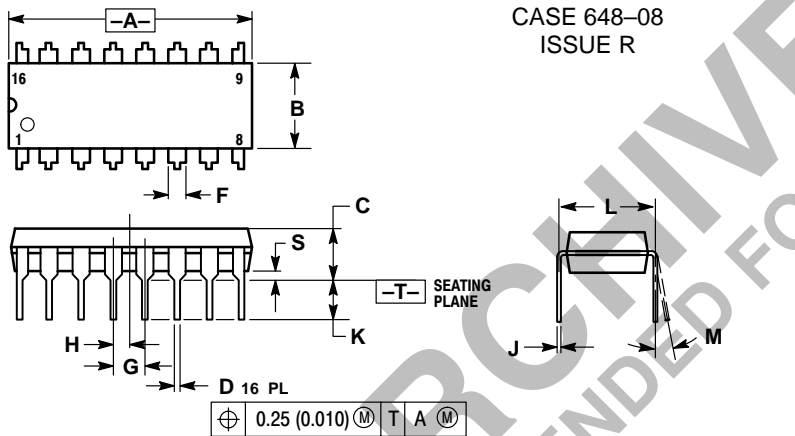
## CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

## PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

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